Power MOSFET, N-Channel, SUPERFET[®] III, FRFET[®], 650 V, 65 A, 40 m Ω

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

Features

- 700 V @ $T_J = 150^{\circ}C$
- Typ. $R_{DS(on)} = 32 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 159 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 1367 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Applications

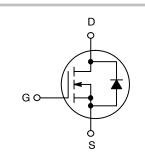
- Telecom / Server Power Supplies
- Industrial Power Supplies
- EV Charger
- UPS / Solar

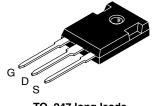


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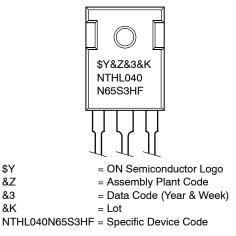
V _{DSS}	R _{DS(ON)} MAX I _D MAX	
650 V	40 m Ω @ 10 V	65 A





TO-247 long leads CASE 340CX

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Paramete	Value	Unit	
V _{DSS}	Drain to Source Voltage		650	V
V _{GSS}	Gate to Source Voltage	– DC	±30	V
		– AC (f > 1 Hz)	±30	
I _D	Drain Current	– Continuous (T _C = 25°C)	65	А
		– Continuous (T _C = 100°C)	45	
I _{DM}	Drain Current	– Pulsed (Note 1)		А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		1009	mJ
I _{AS}	Avalanche Current (Note 2)		9	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		4.46	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		50	
PD	Power Dissipation	(T _C = 25°C)	446	W
		– Derate Above 25°C	3.57	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range	,	-55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering,	1/8" from Case for 5 seconds	300	°C

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 9 \text{ A}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \leq 32.5 \text{ A}, \text{ di/dt} \leq 200 \text{ A/}\mu\text{s}, V_{DD} \leq 400 \text{ V}, \text{ starting } T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.28	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NTHL040N65S3HF	NTHL040N65S3HF	TO-247	Tube	N/A	N/A	30 Units

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARACT	ERISTICS	-				
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I _D = 1 mA, T _J = 25°C	650			V
		V_{GS} = 0 V, I_D = 1 mA, T_J = 150°C	700			V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 15 \text{ mA}$, Referenced to 25°C		0.63		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$			10	μΑ
		V_{DS} = 520 V, T_{C} = 125°C		213		
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ±30 V, V_{DS} = 0 V			±100	nA
ON CHARACTE	ERISTICS		-	-	-	
			1	1	1	1

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 2.1 \text{ mA}$	3.0		5.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V_{GS} = 10 V, I _D = 32.5 A		32	40	mΩ
9fs	Forward Transconductance	V_{DS} = 20 V, I _D = 32.5 A		48		S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz	5945	pF
C _{oss}	Output Capacitance		135	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	1367	pF
C _{oss(er.)}	Energy Related Output Capacitance	$V_{DS} = 0$ V to 400 V, $V_{GS} = 0$ V	245	pF
Q _{g(tot)}	Total Gate Charge at 10V	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 32.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	159	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	46	nC
Q _{gd}	Gate to Drain "Miller" Charge	1	64	nC
ESR	Equivalent Series Resistance	f = 1 MHz	1.2	Ω

SWITCHING CHARACTERISTICS

t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 32.5 \text{ A},$	40	ns
t _r	Turn-On Rise Time	V _{GS} = 10 V, R _g = 2.2 Ω (Note 4)	32	ns
t _{d(off)}	Turn-Off Delay Time		102	ns
t _f	Turn-Off Fall Time		26	ns

SOURCE-DRAIN DIODE CHARACTERISTICS

۱ _S	Maximum Continuous Source to Drain Diode Forward Current			65	А
I _{SM}	Maximum Pulsed Source to Drain Diode Forward Current			162.5	А
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 32.5 A		1.3	V
t _{rr}	Reverse Recovery Time	$V_{DD} = 400$ V, $I_{SD} = 32.5$ A, $dI_F/dt = 100$ A/µs	160		ns
Q _{rr}	Reverse Recovery Charge		874		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

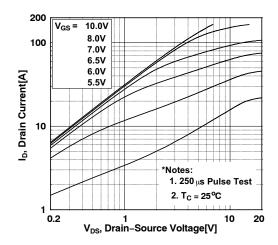


Figure 1. On–Region Characteristics

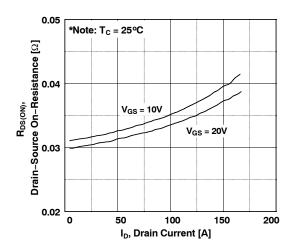


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

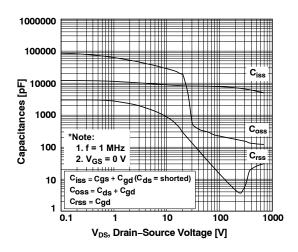


Figure 5. Capacitance Characteristics

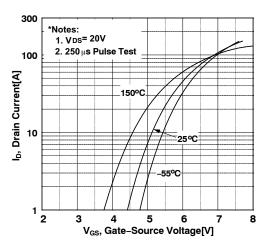


Figure 2. Transfer Characteristics

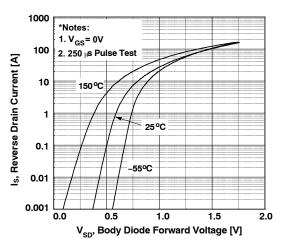


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

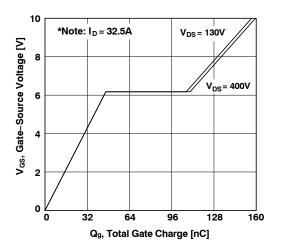
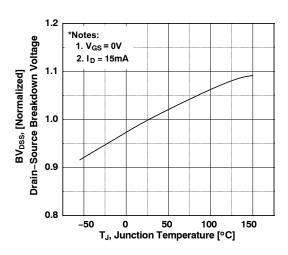
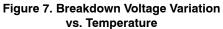


Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





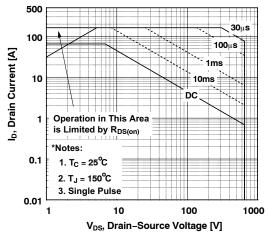


Figure 9. Maximum Safe Operating Area

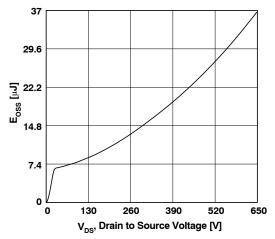


Figure 11. Eoss vs. Drain to Source Voltage

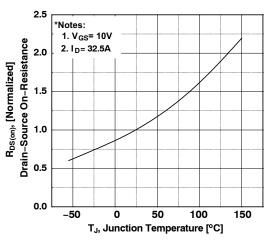
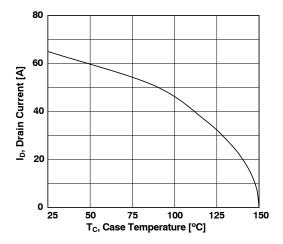
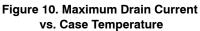


Figure 8. On–Resistance Variation vs. Temperature





TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

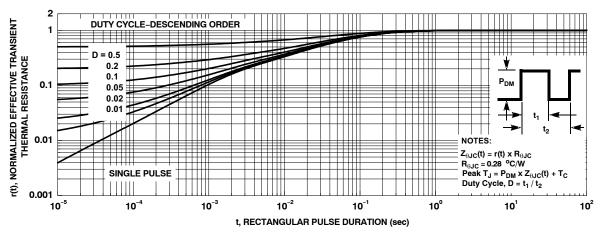
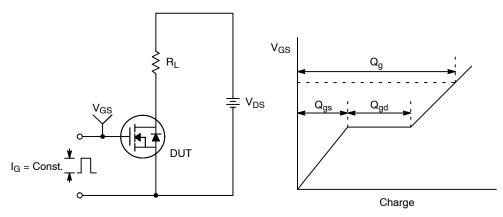


Figure 12. Transient Thermal Response Curve





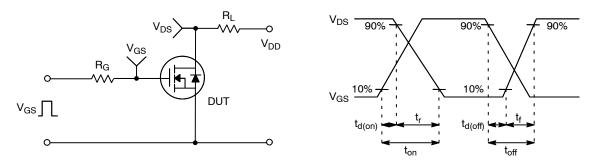


Figure 14. Resistive Switching Test Circuit & Waveforms

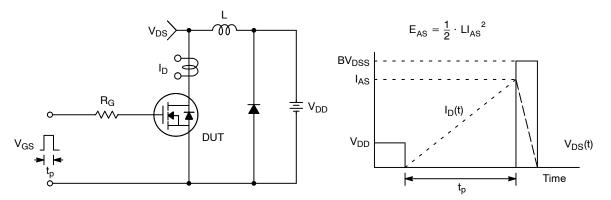


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

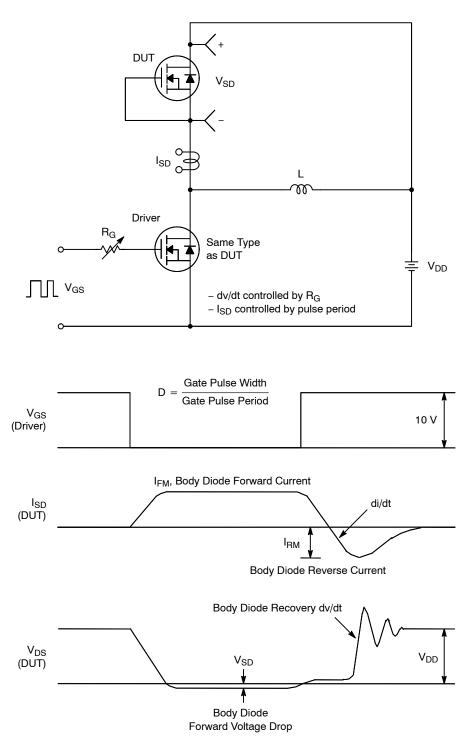


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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